

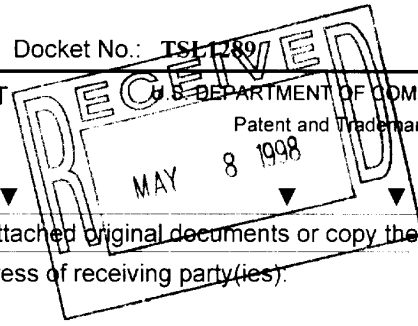
06-03-1998



100726820

Docket No.: TSI 12807

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office



Tab settings

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

MCD 5-8-98

1. Name of conveying party(ies):

Enami Hiroji
Yuji Hamada
Akihiro Nakamura

Additional names(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):

Name: Dow Corning Toray Silicone Company, LTD.

Address: 4th Floor, AIG Building

1-1-3, Marunouchi, Chiyoda-ku,

City: Tokyo 100

State/Prov.:

Country: Japan

ZIP:

Additional name(s) & address(es) Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date: February 6th & 9th, 1998

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No.	Filing date	B. Patent No.(s)
09/022,503	February 12, 1998	

06/02/1998 TSI10072 0000013 041520 09022503
Sale Ref: 00000172 MM: 041520 09022503
01 FC:581 40.00 CH

Additional numbers Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Sharon K. Severance

Registration No. 34,010

Address: Dow Corning Corporation

Patent Department - Mail CO1232

P. O. Box 994

City: Midland State/Prov.: MI

Country: US ZIP: 48686-0994

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41): \$ 40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number:

04-1520

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Sharon K. Severance

Sharon K. Severance

May 4, 1998

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and

PATENT

REEL: 9201 FRAME: 0424

A S S I G N M E N T

WHEREAS We, ENAMI HIROJI, YUJI HAMADA and AKIHIRO NAKAMURA
have invented certain new and useful improvements in

CURABLE SILICONE COMPOSITION

for which application for United States Letters Patent has been executed by us on the 6th & 9th
of February, 1998; and,

WHEREAS, DOW CORNING TORAY SILICONE COMPANY, LTD., 4th Floor, AIG Building, 1-1-3,
Marunouchi, Chiyoda-ku, Tokyo 100, JAPAN, is desirous of acquiring the said invention and said
application and any and all Letters Patent that may be obtained therefor or thereupon, and all
reissues and extensions thereof;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in
consideration of the sum of 250 Yen, and other good and valuable considerations, to us
in hand paid by the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, the receipt of which is
hereby acknowledged, we have sold, assigned, transferred and set over and by these presents do
sell, assign, transfer and set over unto the said DOW CORNING TORAY SILICONE COMPANY, LTD., its
successors, and assigns, the full and exclusive right, title and interest in and to said
invention and said application for Letters Patent of the United States therefor, and in and to
any Divisions and Continuations thereof and in and to any and all United States Letters Patent
and reissues and extensions thereof that may be issued for the said invention, to have and to
hold for its own use and behalf and the use and behalf of its successors and assigns as fully and
entirely as the same might be enjoyed by us if this sale and assignment had not been made; and

HEREBY AUTHORIZE and request the Commissioner of Patents and Trademarks to issue
the said Letters Patent and any reissues and extensions thereof to the said DOW CORNING TORAY
SILICONE COMPANY, LTD. as assigns of the entire right, title and interest in and to the said
invention and said application and Letters Patent issued therefor or thereupon; and

HEREBY AGREE to execute all instruments and documents within our power which may
be necessary for the carrying out of this assignment in full; and to execute any divisional or
continuing application or applications which may be necessary or proper to obtain full protection
on the invention hereby assigned; and to execute any and all supplemental oaths and preliminary
statements should the same be proper and necessary in the prosecution of the aforesaid
applications; and

HEREBY FURTHER ASSIGN unto the said DOW CORNING TORAY SILICONE COMPANY, LIMITED,
its successors, and assigns, the whole right, title and interest in and to the invention
disclosed in the said application throughout all countries foreign to the United States, and do

hereby ratify any acts of the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns, in applying for patents therefor in its own name in countries where such procedure is proper and do agree to execute applications for said invention in the several countries where it is necessary that the same be executed by the inventors, and to execute assignments of such applications and the patents to be obtained therefor to the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns.

IN WITNESS WHEREOF I have hereunto set my hand

Enami Hiroji

ENAMI HIROJI

Dated: 1998 / Feb / 6

This is to certify that ENAMI HIROJI has signed this document in my presence this 6th day of February, 1998, Japan.

Hiromi Fujita

Signature of Witness

HIROMI FUJITA

IN WITNESS WHEREOF I have hereunto set my hand

Yuji Hamada

YUJI HAMADA

Dated: 1998 / Feb / 9

This is to certify YUJI HAMADA has signed this document in my presence this 9th day of February, 1998, Japan.

Hiromi Fujita

Signature of Witness

HIROMI FUJITA

IN WITNESS WHEREOF I have hereunto set my hand

AKIHIRO NAKAMURA

AKIHIRO NAKAMURA

Dated: February 6, 1998

This is to certify that AKIHIRO NAKAMURA has signed this document in my presence this 6th
day of February, 1998, Japan.

Hiromi Fujita

Signature of Witness

HIROMI FUJITA